

## IPP60R060P7-VB Datasheet

## N-Channel 600V (D-S) Super Junction Power MOSFET

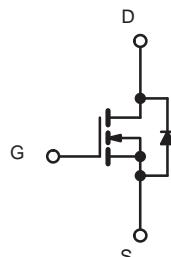
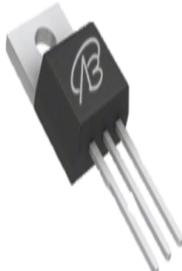
PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	600	
R <sub>DS(on)</sub> at 25 °C (Ω)	V <sub>GS</sub> = 10 V	0.060

## FEATURES

- Low figure-of-merit (FOM) R<sub>on</sub> x Q<sub>g</sub>
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)



TO-220AB



N-ChannelMOSFET

Top View

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	600	V	
Gate-Source Voltage		V <sub>GS</sub>	± 30		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	43	A	
		T <sub>C</sub> = 100 °C	26		
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	130		
Linear Derating Factor			1.67	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	1600	mJ	
Maximum Power Dissipation		P <sub>D</sub>	240	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	dV/dt	50	V/ns	
Reverse Diode dV/dt <sup>d</sup>			15		
Soldering Recommendations (Peak Temperature) <sup>c</sup>			260	°C	
for 10 s					

## Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V<sub>DD</sub> = 100 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>G</sub> = 25 Ω, I<sub>AS</sub> = 21 A.
- c. 1.6 mm from case.
- d. I<sub>SD</sub> ≤ I<sub>D</sub>, dI/dt = 100 A/μs, starting T<sub>J</sub> = 25 °C.

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	$R_{thJA}$	-	62	$^{\circ}\text{C}/\text{W}$			
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.7				
SPECIFICATIONS ( $T_J = 25^{\circ}\text{C}$ , unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 1 \text{ mA}$		600	-	-	
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25^{\circ}\text{C}$ , $I_D = 1 \text{ mA}$		-	0.70	-	
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$		2.5	-	4.5	
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}$		-	-	$\pm 100$	
		$V_{GS} = \pm 30 \text{ V}$		-	-	$\pm 1$	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 480 \text{ V}$ , $V_{GS} = 0 \text{ V}$		-	-	1	
		$V_{DS} = 480 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 125^{\circ}\text{C}$		-	-	100	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$	$I_D = 14.5 \text{ A}$	-	0.060	-	
Forward Transconductance	$g_{fs}$	$V_{DS} = 30 \text{ V}$ , $I_D = 14.5 \text{ A}$		-	5.6	-	
Dynamic							
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}$ , $V_{DS} = 100 \text{ V}$ , $f = 1 \text{ MHz}$		-	4400	-	
Output Capacitance	$C_{oss}$			-	80	-	
Reverse Transfer Capacitance	$C_{rss}$			-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	$C_{o(er)}$	$V_{DS} = 0 \text{ V}$ to $520 \text{ V}$ , $V_{GS} = 0 \text{ V}$		-	62	-	
Effective Output Capacitance, Time Related <sup>b</sup>	$C_{o(tr)}$			-	213	-	
Total Gate Charge	$Q_g$			-	6.3	-	
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$	$I_D = 8 \text{ A}$ , $V_{DS} = 520 \text{ V}$	-	15	-	
Gate-Drain Charge	$Q_{gd}$			-	1.9	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 520 \text{ V}$ , $I_D = 8 \text{ A}$ , $V_{GS} = 10 \text{ V}$ , $R_g = 9.1 \Omega$		-	18	25	
Rise Time	$t_r$			-	24	55	
Turn-Off Delay Time	$t_{d(off)}$			-	8.0	-	
Fall Time	$t_f$			-	1.2	-	
Gate Input Resistance	$R_g$	$f = 1 \text{ MHz}$ , open drain		-	0.8	-	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	43	
Pulsed Diode Forward Current	$I_{SM}$			-	-	130	
Diode Forward Voltage	$V_{SD}$	$T_J = 25^{\circ}\text{C}$ , $I_S = 8 \text{ A}$ , $V_{GS} = 0 \text{ V}$		-	-	1.5	
Reverse Recovery Time	$t_{rr}$	$T_J = 25^{\circ}\text{C}$ , $I_F = I_S = 8 \text{ A}$ , $dl/dt = 100 \text{ A}/\mu\text{s}$ , $V_R = 400 \text{ V}$		-	475	-	
Reverse Recovery Charge	$Q_{rr}$			-	5.8	-	
Reverse Recovery Current	$I_{RRM}$			-	35	-	

**Notes**

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .  
 b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

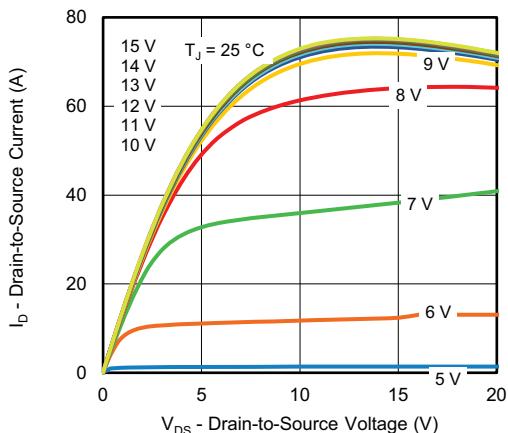
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)


Fig. 1 - Typical Output Characteristics

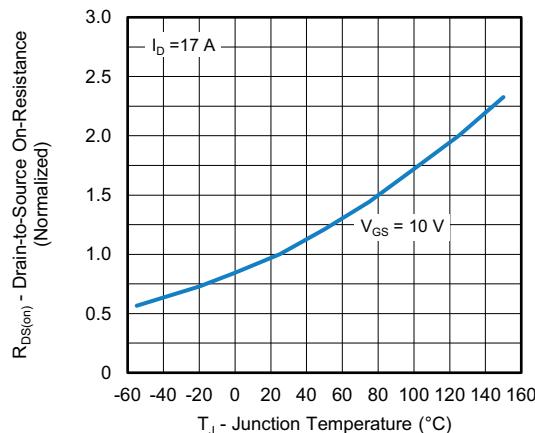


Fig. 4 - Normalized On-Resistance vs. Temperature

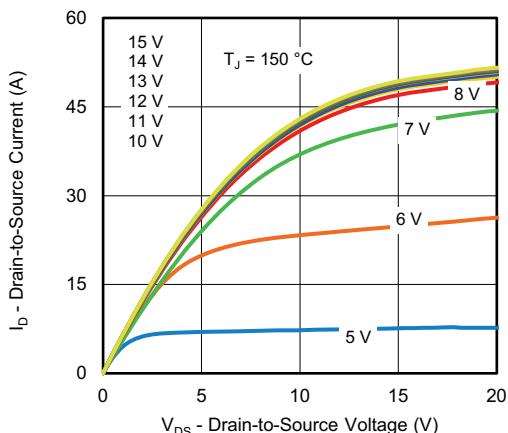


Fig. 2 - Typical Output Characteristics

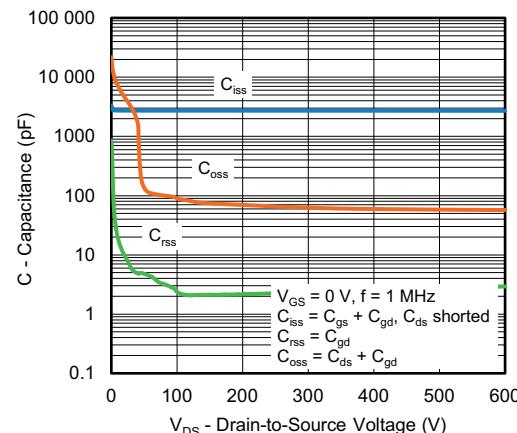


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

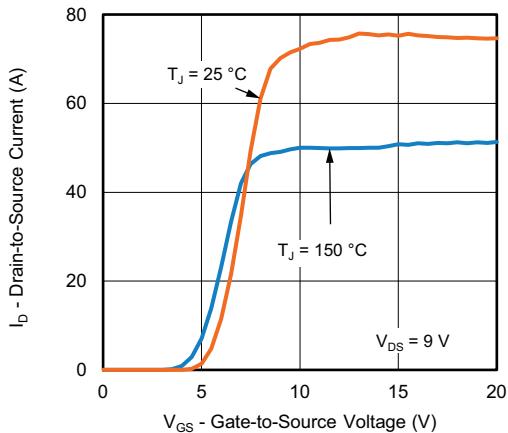
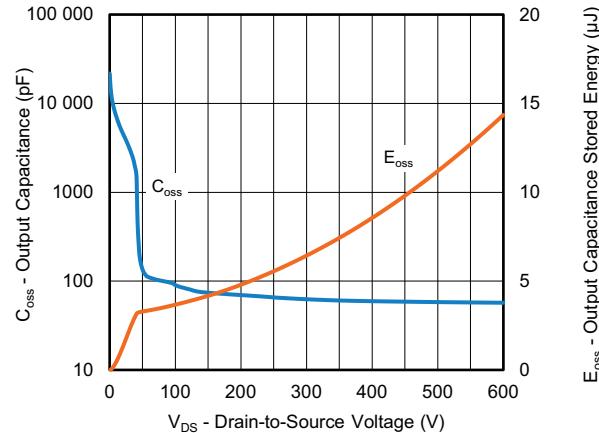


Fig. 3 - Typical Transfer Characteristics

Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$

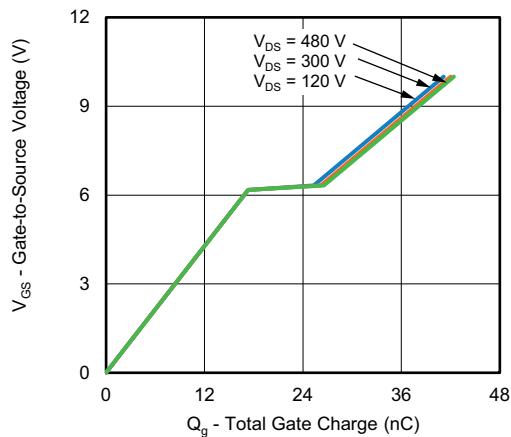


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

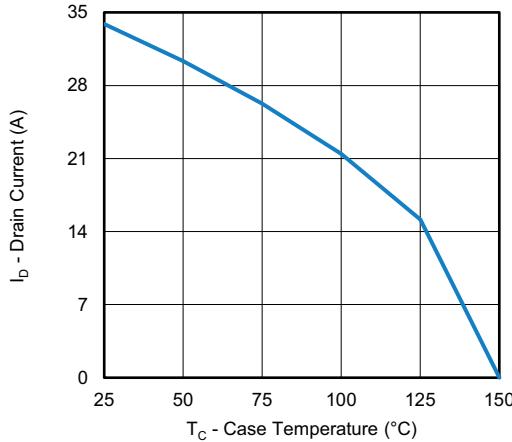


Fig. 10 - Maximum Drain Current vs. Case Temperature

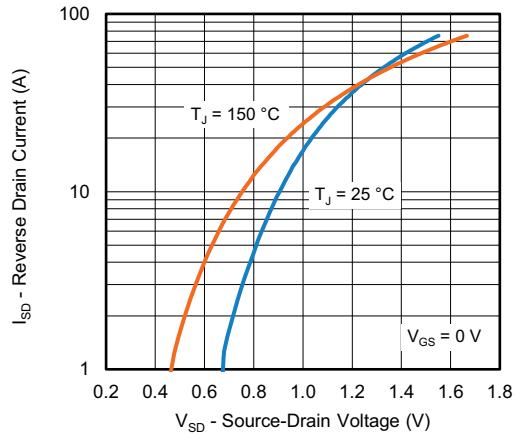


Fig. 8 - Typical Source-Drain Diode Forward Voltage

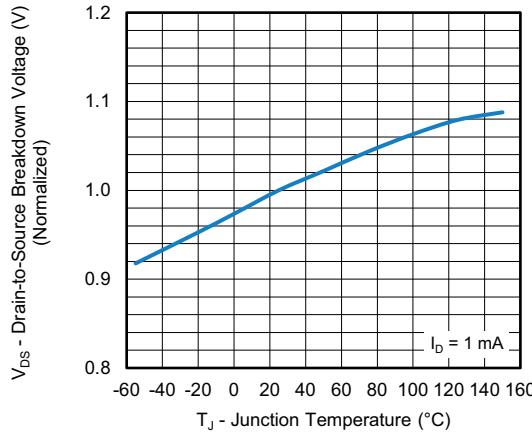


Fig. 11 - Temperature vs. Drain-to-Source Voltage

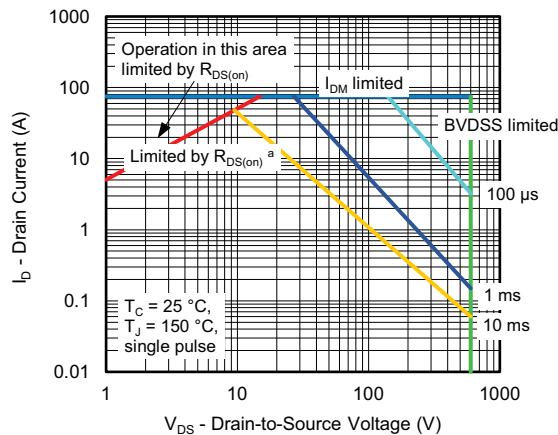


Fig. 9 - Maximum Safe Operating Area

**Note**a.  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

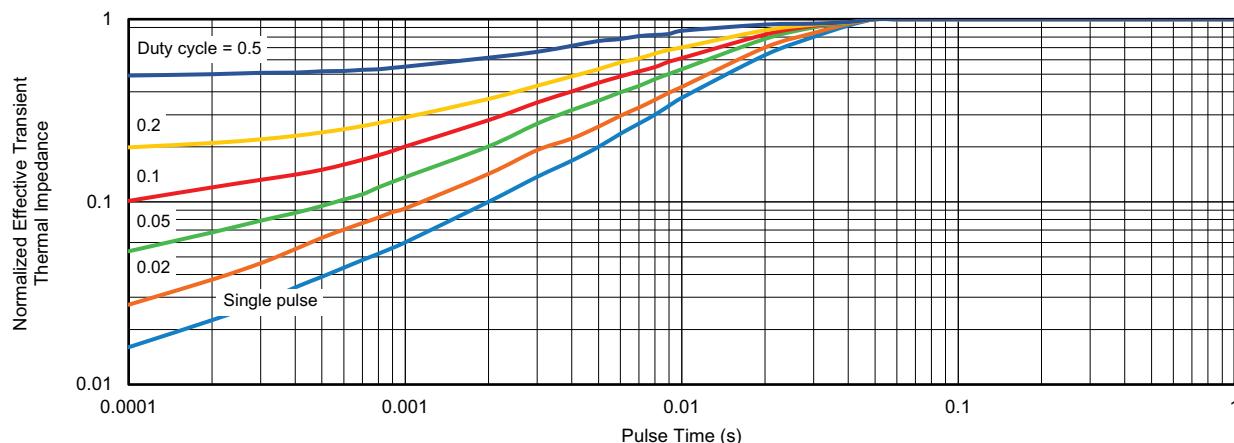


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

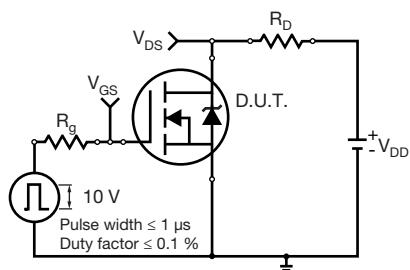


Fig. 13 - Switching Time Test Circuit

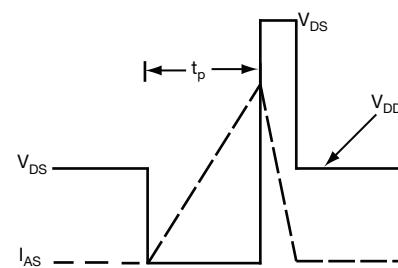


Fig. 16 - Unclamped Inductive Waveforms

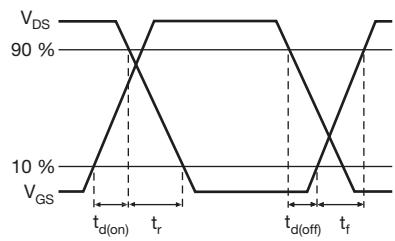


Fig. 14 - Switching Time Waveforms

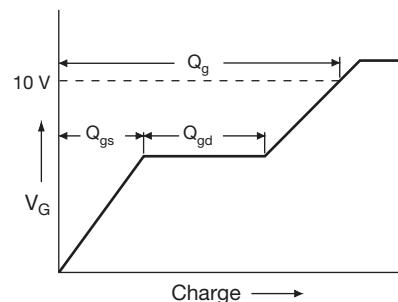


Fig. 17 - Basic Gate Charge Waveform

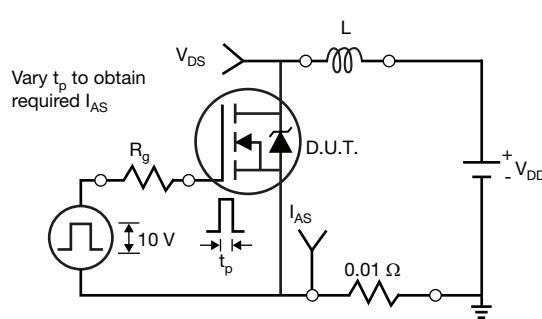


Fig. 15 - Unclamped Inductive Test Circuit

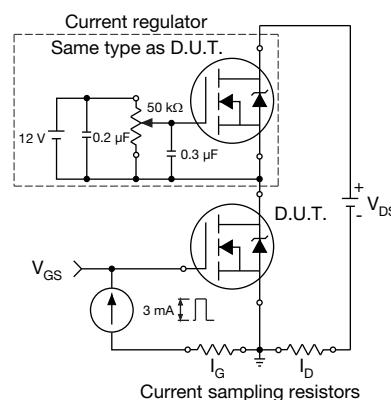
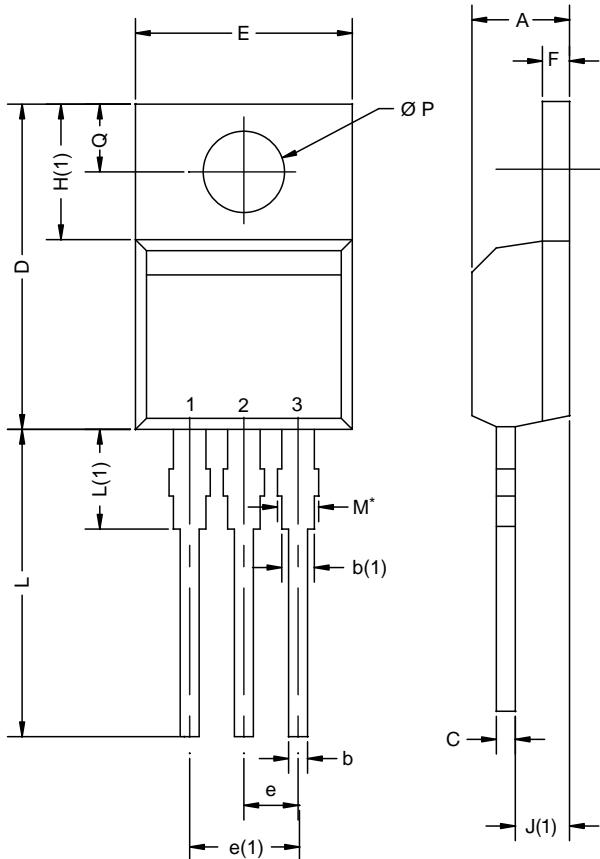


Fig. 18 - Gate Charge Test Circuit

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DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
c	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
E	10.04	10.51	0.395	0.414
e	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
Ø P	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118

## Notes

\* M = 1.32 mm to 1.62 mm (dimension including protrusion)  
Heatsink hole for HVM

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